



# STP20NE06L STP20NE06LFP

N - CHANNEL 60V - 0.06  $\Omega$  - 20A TO-220/TO-220FP  
STripFET™ POWER MOSFET

| TYPE         | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|--------------|------------------|---------------------|----------------|
| STP20NE06L   | 60 V             | < 0.07 $\Omega$     | 20 A           |
| STP20NE06LFP | 60 V             | < 0.07 $\Omega$     | 13 A           |

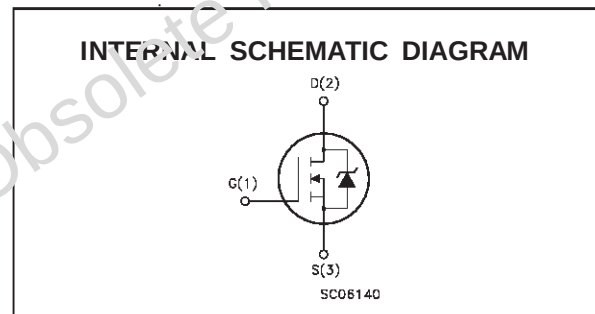
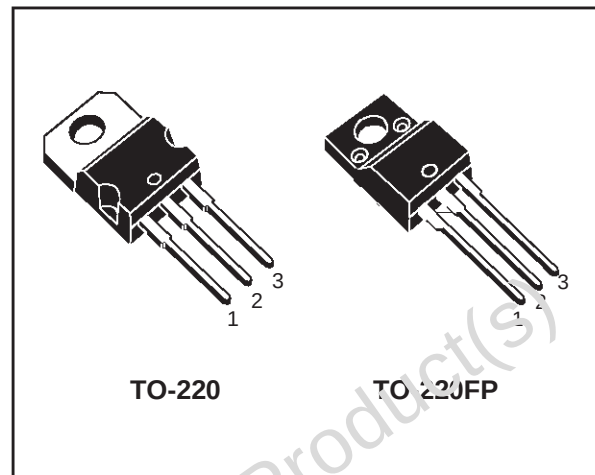
- TYPICAL R<sub>DS(on)</sub> = 0.06  $\Omega$
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- LOW GATE CHARGE 100 °C
- APPLICATION ORIENTED CHARACTERIZATION

## DESCRIPTION

This Power Mosfet is the latest development of STMicroelectronics unique " Single Feature Size™ " strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## APPLICATIONS

- DC MOTOR CONTROL
- DC-DC & DC-AC CONVERTERS
- SYNCHRONOUS RECTIFICATION



## ABSOLUTE MAXIMUM RATINGS

| Symbol              | Parameter                                              | Value      |             | Unit |
|---------------------|--------------------------------------------------------|------------|-------------|------|
|                     |                                                        | STP20NE06  | STP20NE06FP |      |
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)             | 60         |             | V    |
| V <sub>DGR</sub>    | Drain- gate Voltage (R <sub>GS</sub> = 20 k $\Omega$ ) | 60         |             | V    |
| V <sub>GS</sub>     | Gate-source Voltage                                    | $\pm 20$   |             | V    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 25 °C   | 20         | 13          | A    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 100 °C  | 14         | 9           | A    |
| I <sub>DM</sub> (•) | Drain Current (pulsed)                                 | 80         | 80          | A    |
| P <sub>tot</sub>    | Total Dissipation at T <sub>c</sub> = 25 °C            | 70         | 30          | W    |
|                     | Derating Factor                                        | 0.47       | 0.2         | W/°C |
| V <sub>ISO</sub>    | Insulation Withstand Voltage (DC)                      | —          | 2000        | V    |
| dv/dt               | Peak Diode Recovery voltage slope                      | 7          |             | V/ns |
| T <sub>stg</sub>    | Storage Temperature                                    | -65 to 175 |             | °C   |
| T <sub>j</sub>      | Max. Operating Junction Temperature                    | 175        |             | °C   |

(•) Pulse width limited by safe operating area

(1) I<sub>SD</sub>  $\leq$  20 A, di/dt  $\leq$  300 A/ $\mu$ s, V<sub>DD</sub>  $\leq$  V<sub>(BR)DSS</sub>, T<sub>j</sub>  $\leq$  T<sub>JMAX</sub>

## THERMAL DATA

|                       |                                                | TO-220 | TO-220FP |      |
|-----------------------|------------------------------------------------|--------|----------|------|
| R <sub>thj-case</sub> | Thermal Resistance Junction-case Max           | 2.14   | 5        | °C/W |
| R <sub>thj-amb</sub>  | Thermal Resistance Junction-ambient Max        | 62.5   |          | °C/W |
| R <sub>thc-sink</sub> | Thermal Resistance Case-sink Typ               | 0.5    |          | °C/W |
| T <sub>l</sub>        | Maximum Lead Temperature For Soldering Purpose | 300    |          | °C   |

## AVALANCHE CHARACTERISTICS

| Symbol          | Parameter                                                                                                                  | Max Value | Unit |
|-----------------|----------------------------------------------------------------------------------------------------------------------------|-----------|------|
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T <sub>j</sub> max)                                | 20        | A    |
| E <sub>AS</sub> | Single Pulse Avalanche Energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 35 V) | 100       | mJ   |

ELECTRICAL CHARACTERISTICS (T<sub>case</sub> = 25 °C unless otherwise specified)

## OFF

| Symbol               | Parameter                                             | Test Conditions                                                                      | Min. | Typ. | Max.    | Unit     |
|----------------------|-------------------------------------------------------|--------------------------------------------------------------------------------------|------|------|---------|----------|
| V <sub>(BR)DSS</sub> | Drain-source Breakdown Voltage                        | I <sub>D</sub> = 250 μA V <sub>GS</sub> = 0                                          | 60   |      |         | V        |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0) | V <sub>DS</sub> = Max Rating<br>V <sub>DS</sub> = Max Rating T <sub>c</sub> = 125 °C |      |      | 1<br>10 | μA<br>μA |
| I <sub>GSS</sub>     | Gate-body Leakage Current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 20 V                                                             |      |      | ± 100   | nA       |

## ON (\*)

| Symbol              | Parameter                         | Test Conditions                                                                             | Min. | Typ.         | Max.          | Unit   |
|---------------------|-----------------------------------|---------------------------------------------------------------------------------------------|------|--------------|---------------|--------|
| V <sub>GS(th)</sub> | Gate Threshold Voltage            | V <sub>DS</sub> = V <sub>GS</sub> I <sub>D</sub> = 250 μA                                   | 1    |              |               | V      |
| R <sub>DS(on)</sub> | Static Drain-source On Resistance | V <sub>GS</sub> = 5 V I <sub>D</sub> = 10 A<br>V <sub>GS</sub> = 10 V I <sub>D</sub> = 10 A |      | 0.07<br>0.06 | 0.085<br>0.07 | Ω<br>Ω |
| I <sub>D(on)</sub>  | On State Drain Current            | V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>DS(on)max</sub><br>V <sub>GS</sub> = 10 V     | 20   |              |               | A      |

## DYNAMIC

| Symbol              | Parameter                    | Test Conditions                                                                     | Min. | Typ. | Max. | Unit |
|---------------------|------------------------------|-------------------------------------------------------------------------------------|------|------|------|------|
| g <sub>fs</sub> (*) | Forward Transconductance     | V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>DS(on)max</sub> I <sub>D</sub> = 10 A | 5    | 9    |      | S    |
| C <sub>iss</sub>    | Input Capacitance            | V <sub>DS</sub> = 25 V f = 1 MHz V <sub>GS</sub> = 0                                |      | 800  |      | pF   |
| C <sub>oss</sub>    | Output Capacitance           |                                                                                     |      | 125  |      | pF   |
| C <sub>rss</sub>    | Reverse Transfer Capacitance |                                                                                     |      | 40   |      | pF   |

**ELECTRICAL CHARACTERISTICS** (continued)**SWITCHING ON**

| Symbol      | Parameter          | Test Conditions                                                                 | Min. | Typ. | Max. | Unit |
|-------------|--------------------|---------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = 30\text{ V}$ $I_D = 10\text{ A}$                                      |      | 20   |      | ns   |
| $t_r$       | Rise Time          | $R_G = 4.7\text{ }\Omega$ $V_{GS} = 5\text{ V}$<br>(see test circuit, figure 3) |      | 45   |      | ns   |
| $Q_g$       | Total Gate Charge  | $V_{DD} = 48\text{ V}$ $I_D = 20\text{ A}$ $V_{GS} = 5\text{ V}$                |      | 14   | 20   | nC   |
| $Q_{gs}$    | Gate-Source Charge |                                                                                 |      | 8    |      | nC   |
| $Q_{gd}$    | Gate-Drain Charge  |                                                                                 |      | 4    |      | nC   |

**SWITCHING OFF**

| Symbol         | Parameter             | Test Conditions                                                                 | Min. | Typ. | Max. | Unit |
|----------------|-----------------------|---------------------------------------------------------------------------------|------|------|------|------|
| $t_r(v_{off})$ | Off-voltage Rise Time | $V_{DD} = 48\text{ V}$ $I_D = 20\text{ A}$                                      |      | 10   |      | ns   |
| $t_f$          | Fall Time             | $R_G = 4.7\text{ }\Omega$ $V_{GS} = 5\text{ V}$<br>(see test circuit, figure 5) |      | 25   |      | ns   |
| $t_c$          | Cross-over Time       |                                                                                 |      | 42   |      | ns   |

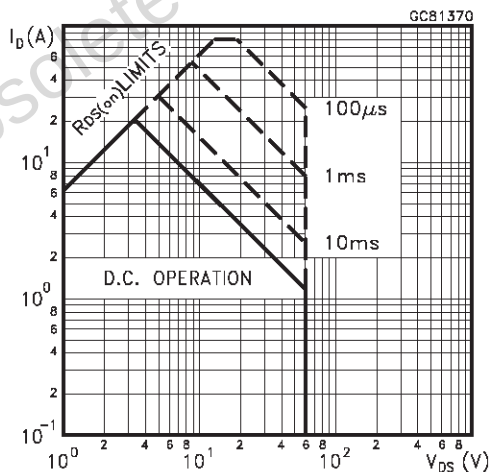
**SOURCE DRAIN DIODE**

| Symbol             | Parameter                     | Test Conditions                                                                                                                                       | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $I_{SD}$           | Source-drain Current          |                                                                                                                                                       |      |      | 20   | A    |
| $I_{SDM}(\bullet)$ | Source-drain Current (pulsed) |                                                                                                                                                       |      |      | 80   | A    |
| $V_{SD} (*)$       | Forward On Voltage            | $I_{SD} = 20\text{ A}$ $V_{GS} = 0$                                                                                                                   |      |      | 1.5  | V    |
| $t_{rr}$           | Reverse Recovery Time         | $I_{SD} = 20\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 30\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$<br>(see test circuit, figure 5) |      | 65   |      | ns   |
| $Q_{rr}$           | Reverse Recovery Charge       |                                                                                                                                                       |      | 130  |      | nC   |
| $I_{RRM}$          | Reverse Recovery Current      |                                                                                                                                                       |      | 4    |      | A    |

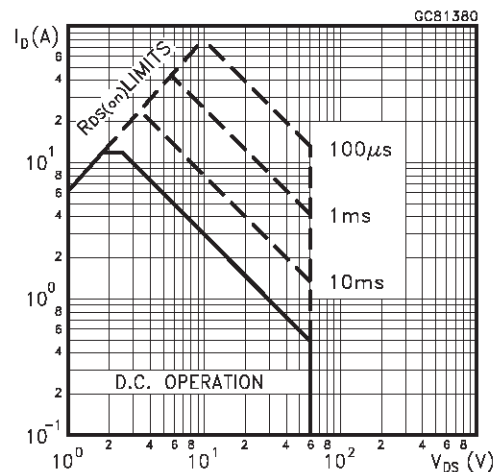
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5 %

(•) Pulse width limited by safe operating area

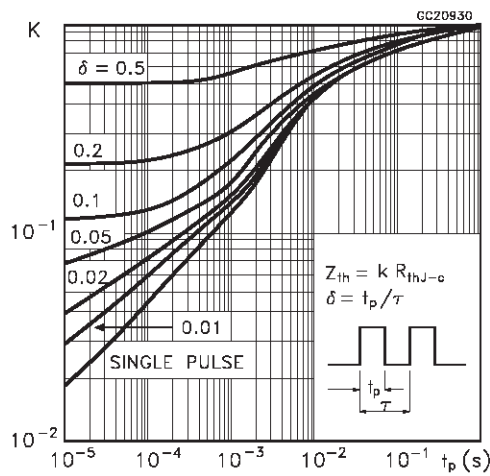
Safe Operating Area for TO-220



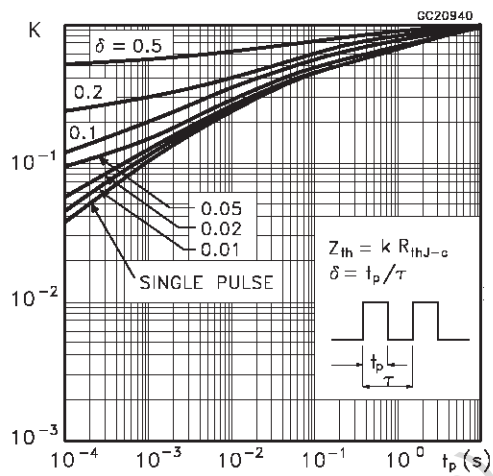
Safe Operating Area for TO-220FP



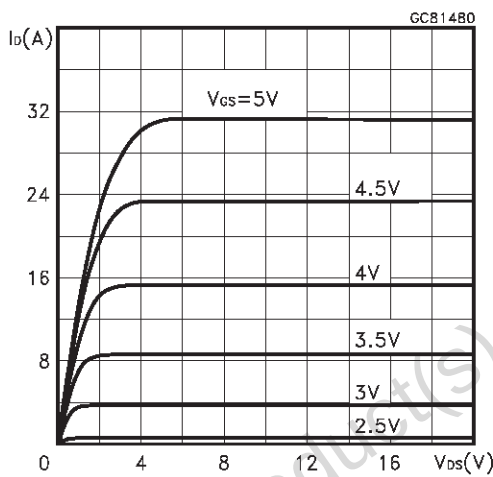
Thermal Impedance for TO-220



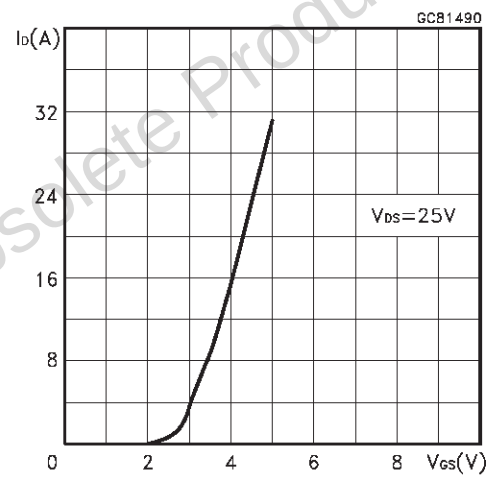
Thermal Impedance for TO-220FP



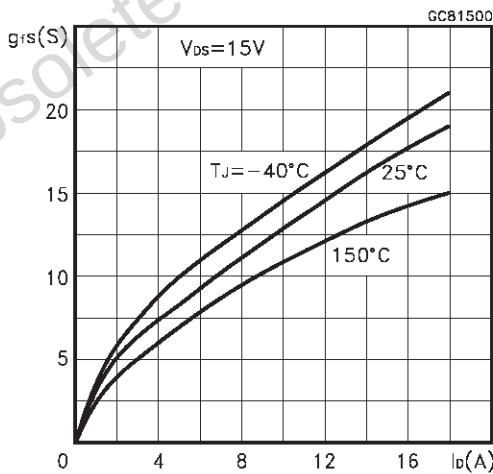
Output Characteristics



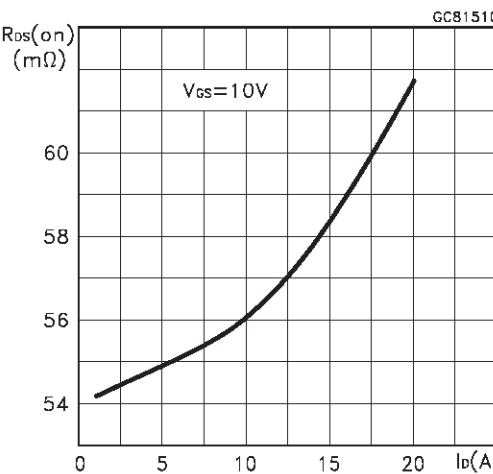
Transfer Characteristics



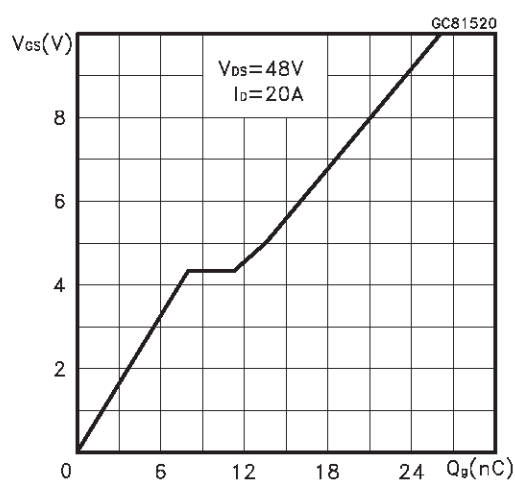
Transconductance



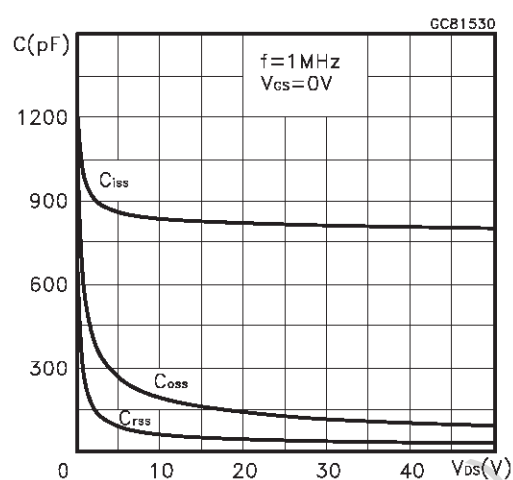
Static Drain-source On Resistance



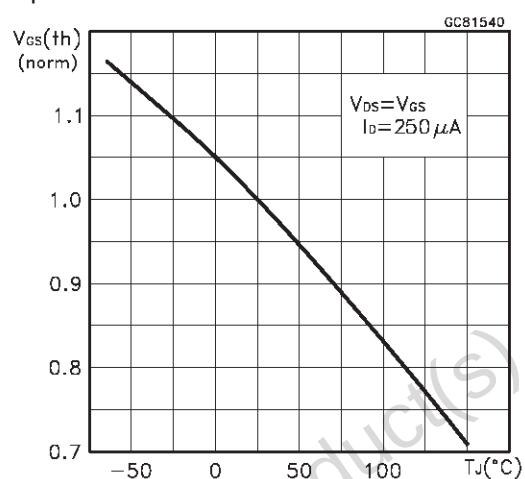
Gate Charge vs Gate-source Voltage



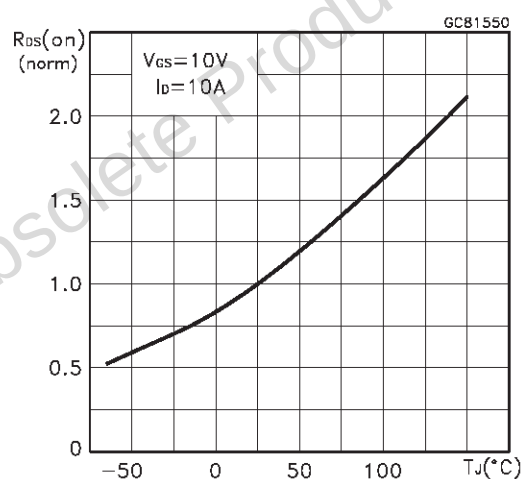
Capacitance Variations



Normalized Gate Threshold Voltage vs Temperature



Normalized On Resistance vs Temperature



Source-drain Diode Forward Characteristics

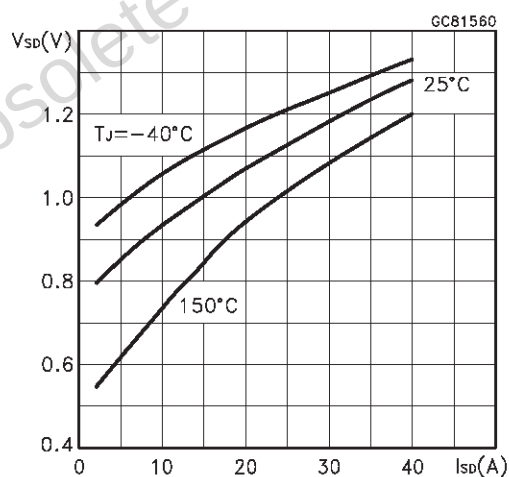


**Fig. 1: Unclamped Inductive Load Test Circuit**

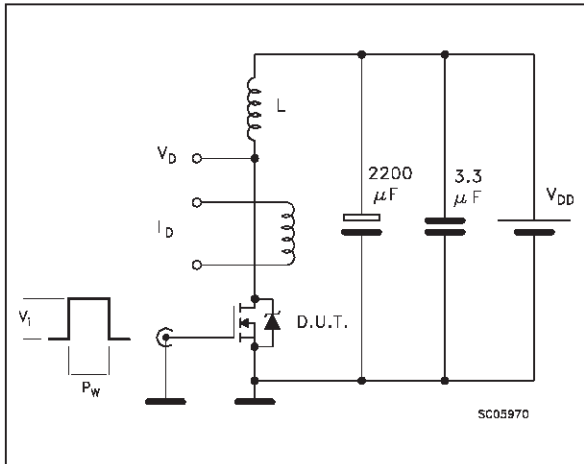


**Fig. 2: Unclamped Inductive Waveform**

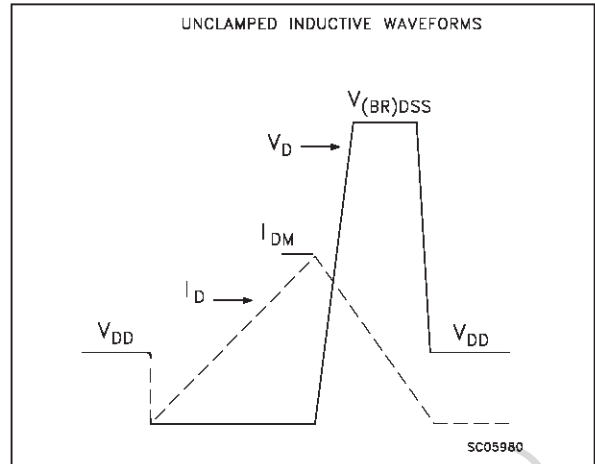


**Fig. 3: Switching Times Test Circuits For Resistive Load**

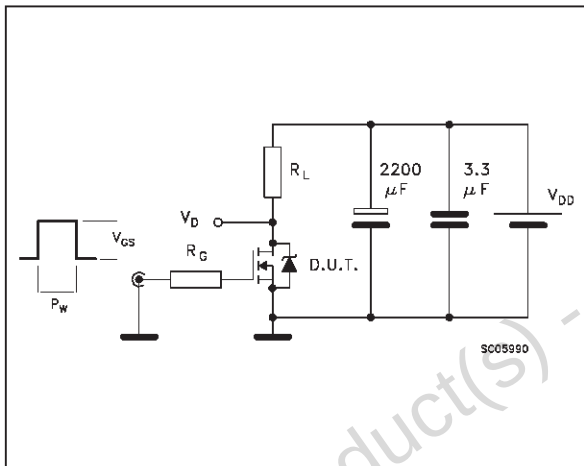


**Fig. 4: Gate Charge test Circuit**

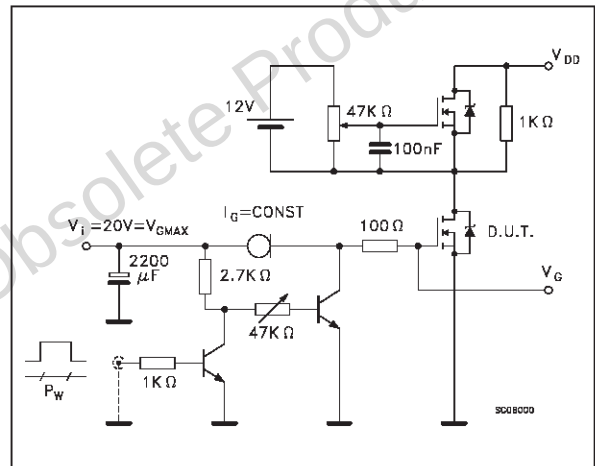
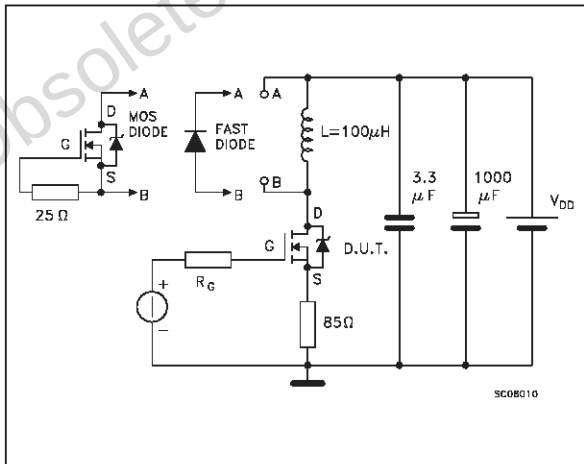
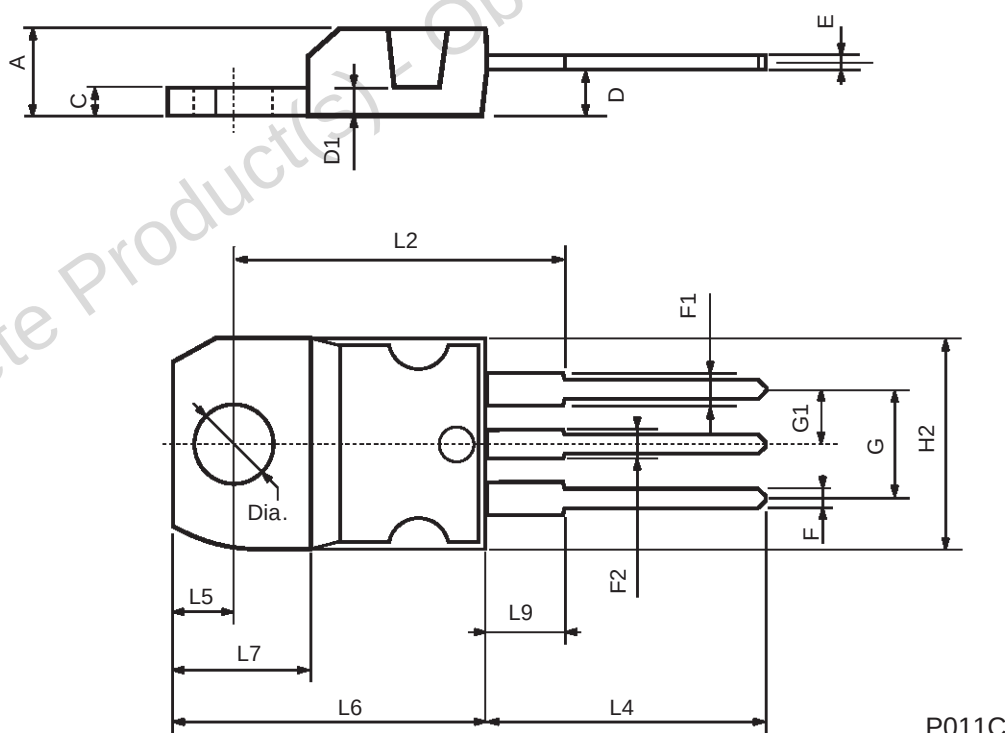


**Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times**



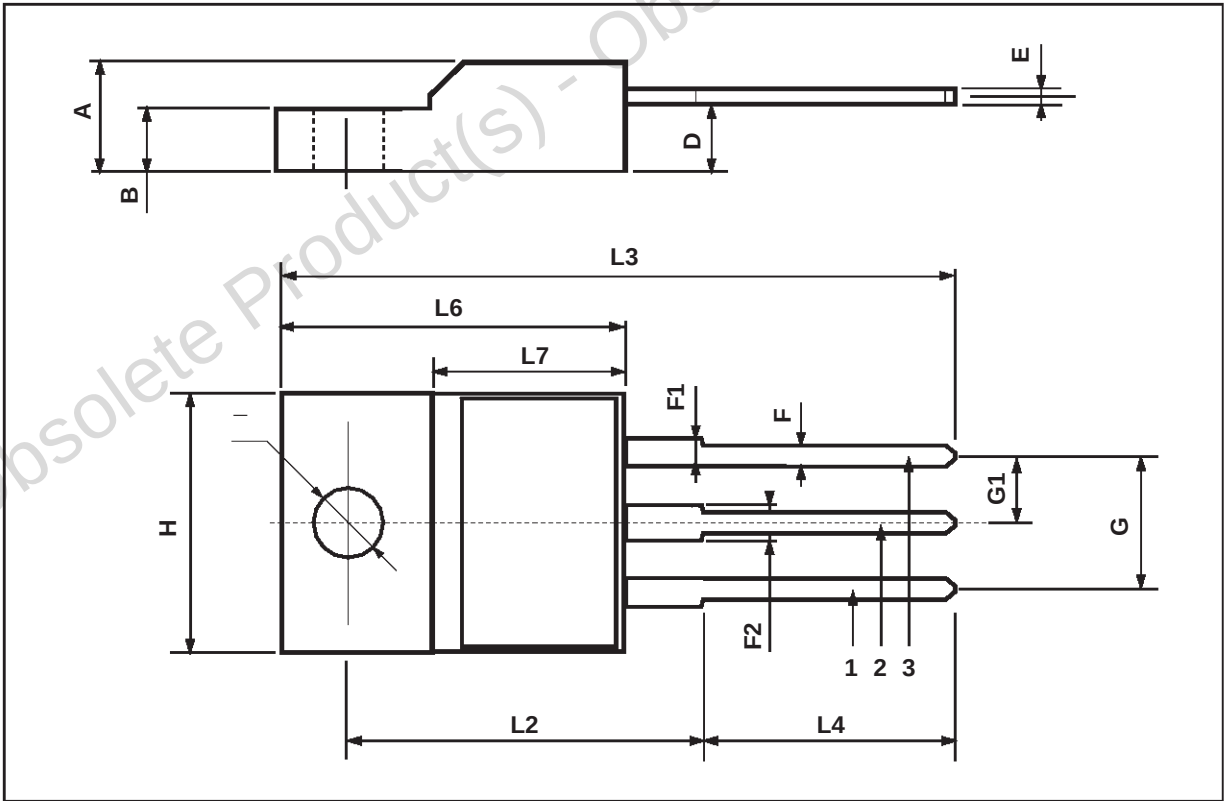
## TO-220 MECHANICAL DATA

| DIM. | mm    |      |       | inch  |       |       |
|------|-------|------|-------|-------|-------|-------|
|      | MIN.  | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 4.40  |      | 4.60  | 0.173 |       | 0.181 |
| C    | 1.23  |      | 1.32  | 0.048 |       | 0.051 |
| D    | 2.40  |      | 2.72  | 0.094 |       | 0.107 |
| D1   |       | 1.27 |       |       | 0.050 |       |
| E    | 0.49  |      | 0.70  | 0.019 |       | 0.027 |
| F    | 0.61  |      | 0.88  | 0.024 |       | 0.034 |
| F1   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| F2   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| G    | 4.95  |      | 5.15  | 0.194 |       | 0.203 |
| G1   | 2.4   |      | 2.7   | 0.094 |       | 0.106 |
| H2   | 10.0  |      | 10.40 | 0.393 |       | 0.409 |
| L2   |       | 16.4 |       |       | 0.645 |       |
| L4   | 13.0  |      | 14.0  | 0.511 |       | 0.551 |
| L5   | 2.65  |      | 2.95  | 0.104 |       | 0.116 |
| L6   | 15.25 |      | 15.75 | 0.600 |       | 0.620 |
| L7   | 6.2   |      | 6.6   | 0.244 |       | 0.260 |
| L9   | 3.5   |      | 3.93  | 0.137 |       | 0.154 |
| DIA. | 3.75  |      | 3.85  | 0.147 |       | 0.151 |



TO-220FP MECHANICAL DATA

| DIM. | mm   |      |      | inch  |       |       |
|------|------|------|------|-------|-------|-------|
|      | MIN. | TYP. | MAX. | MIN.  | TYP.  | MAX.  |
| A    | 4.4  |      | 4.6  | 0.173 |       | 0.181 |
| B    | 2.5  |      | 2.7  | 0.098 |       | 0.106 |
| D    | 2.5  |      | 2.75 | 0.098 |       | 0.108 |
| E    | 0.45 |      | 0.7  | 0.017 |       | 0.027 |
| F    | 0.75 |      | 1    | 0.030 |       | 0.039 |
| F1   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| F2   | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| G    | 4.95 |      | 5.2  | 0.195 |       | 0.204 |
| G1   | 2.4  |      | 2.7  | 0.094 |       | 0.106 |
| H    | 10   |      | 10.4 | 0.393 |       | 0.409 |
| L2   |      | 16   |      |       | 0.630 |       |
| L3   | 28.6 |      | 30.6 | 1.126 |       | 1.204 |
| L4   | 9.8  |      | 10.6 | 0.385 |       | 0.417 |
| L6   | 15.9 |      | 16.4 | 0.626 |       | 0.645 |
| L7   | 9    |      | 9.3  | 0.354 |       | 0.366 |
| Ø    | 3    |      | 3.2  | 0.118 |       | 0.126 |



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